**3GPP TSG-RAN WG4 Meeting # 110 R4-2401070**

**Athens, GR, 26 Feb – 01 Mar, 2024**

**Agenda item:** 7.17

**Source:** Moderator (Huawei, HiSilicon)

**Title:** Topic summary for [110][111] HPUE\_Basket\_Intra-CA\_TDD

**Document for:** Information

# Introduction

*Thread [111] includes following HPUE topics:*

*Topic: Issues for HPUE\_NR\_FR1\_TDD\_intra\_CA\_R18 (Agenda 7.17)*

# Topic #1: HPUE\_NR\_FR1\_TDD\_ intra\_CA\_R18 (7.17)

## Companies’ contributions summary

|  |  |  |
| --- | --- | --- |
| **T-doc number** | **Company** | **Proposals / Observations** |
| **R4-2400832** | CMCC | (HPUE\_NR\_FR1\_TDD\_intra\_CA\_R18) Draft CR for TS 38.101-1 to update NR intra-band CA HPUE requirement on TDD |
| R4-2402319 | Huawei,HiSilicon | Big CR on TS38.101-1 Addition of intra-band CA Combinations |

## Open issues summary

**Issue 1-1-1:**

|  |  |  |
| --- | --- | --- |
| R4-2400832 | CMCC | Title: (HPUE\_NR\_FR1\_TDD\_intra\_CA\_R18) Draft CR for TS 38.101-1 to update NR intra-band CA HPUE requirement on TDD***Summary of change:*** Update PC2 requirements for intra-band CA combination CA\_n79C |

* **Recommended WF:**
	+ **Endorsed**